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June 14, 2007

VIA FACSIMILE - 9 PAGES (Including This Cover)

**Commissioner for Patents
POB 1450, Alexandria, VA 22313-1450
Transmitted to USPTO Central Fax No. 571-273-8300**


Applicants: SHIBATA et al
Serial No.: 10/797,003
Filed: March 11, 2004
For: Mold Die And Method For Manufacturing Semiconductor
Device Using The Same
Art Unit: 2814
Examiner: Chambliss, A.
Docket No. 503.43552X00

Sir:

Applicant hereby transmits the attached "Amendment (8 pages)" regarding the above-identified application.

CERTIFICATE OF TRANSMISSION:

I hereby certify that the attached "Amendment (8 pages)" are being **FORMALLY TRANSMITTED** via the USPTO Central Fax No. 571-273-8300 on 14 June 2007.


Alan E. Schiavelli
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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AMENDMENT

Mail Stop: AF
Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

June 14, 2007

Sir:

This is in response to the Office Action mailed March 14, 2007, in connection with the above-identified application. The amendments are listed below and set forth on the following pages.

Amendments to the Claims;

Remarks are included following the amendments.